

# SILICON POWER TRANSISTOR 2SA1649, 2SA1649-Z

# PNP SILICON EPITAXIAL POWER TRANSISTOR FOR HIGH-SPEED SWITCHING

The 2SA1649 is a mold power transistor developed for highspeed switching and features a very low collector-to-emitter saturation voltage.

This transistor is ideal for use in switching regulators, DC/DC converters, motor drivers, solenoid drivers, and other low-voltage power supply devices, as well as for high-current switching.

#### **FEATURES**

- Available for high-current control in small dimension
- Z type is a lead processed product and is deal for mounting a hybrid IC.
- Mold package that does not require an insulating board or insulation bushing
- Low collector saturation voltage:
   VCE(sat) = -0.3 V MAX. (@Ic = -3 A)
- Fast switching speed:
   tf = 0.3 μs MAX. (@Ic = -3 A)
- · High DC current amplifiers and excellent linearity

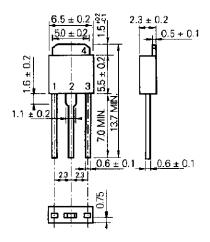
### ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

Parameter	Symbol	Ratings	Unit
Collector to base voltage	VcBO	-40	V
Collector to emitter voltage	VCEO	-30	V
Emitter to base voltage	V <sub>EBO</sub>	-7.0	V
Collector current (DC)	Ic(DC)	-10	Α
Collector current (pulse)	IC(pulse)*	-20	Α
Base current (DC)	I <sub>B(DC)</sub>	-3.5	Α
Total power dissipation	P <sub>T</sub> (Tc = 25 °C)	15	W
Total power dissipation	P⊤ (Ta = 25 °C)	1.0**, 2.0***	W
Junction temperature	Tj	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

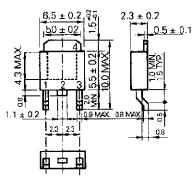
- \*: PW  $\leq$  300  $\mu$ s, duty cycle  $\leq$  10%
- \*\*: Printing board mounted
- \*\*\*: 7.5 mm<sup>2</sup> × 0.7 mm ceramic board mounted

# PACKAGE DRAWING (UNIT: mm)

#### 2SA1649 (MP-3)



#### 2SA1649-Z (MP-3Z)



Electrode Connection

- 1. Base
- 2. Collector
- 3. Emitter
- 4. Fin (collector)

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# **ELECTRICAL CHARACTERISTICS (Ta = 25°C)**

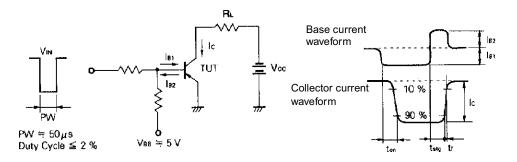
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector to emitter voltage	VCEO(SUS)	Ic = -4.0 A, Iв = -0.4 A, L = 1 mH	-30			V
Collector to emitter voltage	VCEX(SUS)	$I_C = -4.0 \text{ A}, I_{B2} = -I_{B1} = -0.4 \text{ A},$ $V_{BE(OFF)} = 1.5 \text{ V}, L = 180 \ \mu\text{H}, clamped$				V
Collector cutoff current	Ісво	Vce = -30 V, IE = 0			-10	μΑ
Collector cutoff current	ICER	$V_{CE}=-30~V,~R_{BE}=50~\Omega,~Ta=125^{\circ}C$			-1.0	mA
Collector cutoff current	ICEX1	$V_{CE} = -30 \text{ V}, V_{BE(OFF)} = 1.5 \text{ V}$			-10	μΑ
Collector cutoff current	ICEX2	$V_{CE} = -30 \text{ V}, V_{BE(OFF)} = 1.5 \text{ V},$ $Ta = 125^{\circ}C$			-1.0	mA
Emitter cutoff current	ІЕВО	V <sub>EB</sub> = -5.0 V, I <sub>C</sub> = 0			-10	μΑ
DC current gain	h <sub>FE1</sub> *	Vce = -2.0 V, Ic = -0.5 A	100			-
DC current gain	h <sub>FE2</sub> *	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -2.0 \text{ A}$	100	200	400	-
DC current gain	h <sub>FE3</sub> *	$V_{CE} = -2.0 \text{ V, Ic} = -4.0 \text{ A}$	60			-
Collector saturation voltage	VCE(sat)1*	Ic = -3.0  A, IB = -0.2  A			-0.3	V
Collector saturation voltage	VCE(sat)2*	$Ic = -4.0 \text{ A}, I_B = -0.3 \text{ A}$			-0.5	V
Base saturation voltage	V <sub>BE(sat)1</sub> *	$Ic = -3.0 \text{ A}, I_B = -0.2 \text{ A}$			-1.2	V
Base saturation voltage	V <sub>BE(sat)2</sub> *	$Ic = -4.0 \text{ A}, I_B = -0.3 \text{ A}$			-1.5	V
Collector capacitance	Cob	VcB = −10 V, IE = 0, f = 1.0 MHz		250		pF
Gain bandwidth product	f⊤	Vce = -10 V, Ic = -0.5 A		120		MHz
Turn-on time	ton	$Ic = -4.0 \text{ A}, RL = 5 \Omega,$			0.3	μs
Storage time	tstg	$I_{B1} = -I_{B2} = -0.15 \text{ A}, \text{ Vcc } \cong -20 \text{ V}$ Refer to the test circuit.			1.5	μs
Fall time	tf	There to the test endult.			0.3	μs

<sup>\*</sup> Pulse test PW  $\leq$  350  $\mu$ s, duty cycle  $\leq$  2%/pulsed

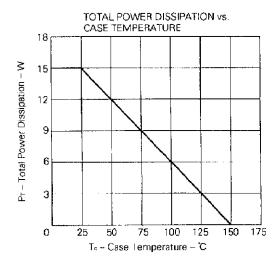
# **hfe CLASSIFICATION**

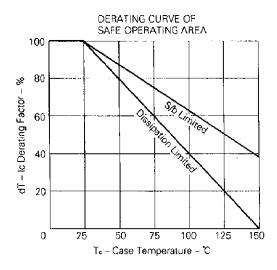
Marking	М	L	K
h <sub>FE2</sub>	100 to 200	150 to 300	200 to 400

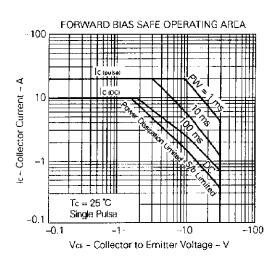
# SWITCHING TIME (ton, tstg, tf) TEST CIRCUIT

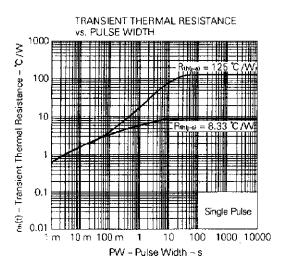


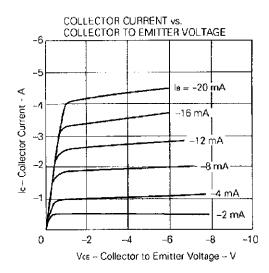
# TYPICAL CHARACTERISTICS (Ta = 25°C)

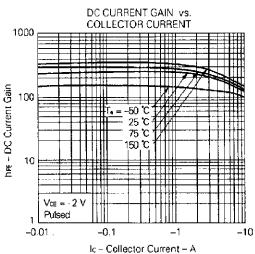


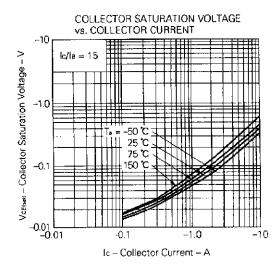


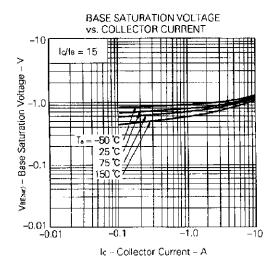


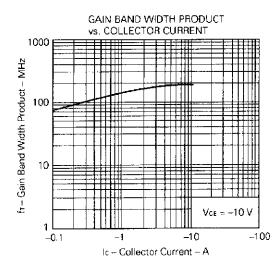


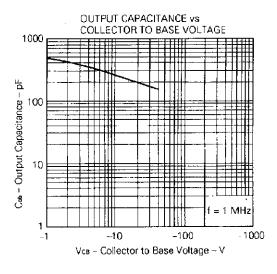


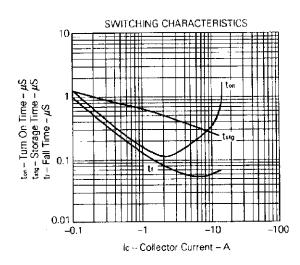


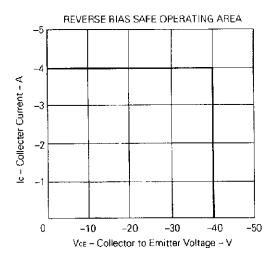














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